20 W stereo power amplifier with volume control

Rev. 01 — 28 April 2006

Preliminary data sheet

1. General description

The TFA9843AJ contains two identical audio power amplifiers. The TFA9843AJ can be used as two Single-Ended (SE) channels with a volume control. The maximum gain is 26 dB.

The TFA9843AJ comes in a 9-pin DIL-bent-SIL (DBS9P) power package. The TFA9843AJ is pin compatible with the TFA9842AJ, TFA9843(B)J, TFA9842(B)J and TFA9841J. The difference between the TFA9843AJ and the TFA9843(B)J, TFA9842(B)J, TFA9841J is the functionality of pin 7. The TFA9843AJ has a volume control on pin 7 (VC). The TFA9843(B)J, TFA9842(B)J and TFA9841J have a mode select on pin 7 (MODE).

The TFA9843AJ contains a unique protection circuit that is solely based on multiple temperature measurements inside the chip. This gives maximum output power for all supply voltages and load conditions with no unnecessary audio holes. Almost any supply voltage and load impedance combination can be made as long as thermal boundary conditions (number of channels used, external heatsink and ambient temperature) allow it.

2. Features

- 2 channel SE: 1 W to 20 W operation possibility
- Soft clipping
- Input clamps
- Volume control
- Standby and Mute mode
- No on or off switching plops
- Low standby current
- High supply voltage ripple rejection
- Outputs short-circuit protected to ground, supply and across the load
- Thermally protected
- Pin compatible with the TFA9842AJ, TFA9843(B)J, TFA9842(B)J, TFA9841J

3. Applications

- CRT TV and LCD TV
- Monitors
- PC speakers
- Boom box
- Mini and micro audio receivers



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4. Quick reference data

Table 1. Quick reference data

 $V_{CC} = 18 \text{ V}; T_{amb} = 25 \text{ °C}; R_L = 4 \Omega; V_{l(VC)} = V_{CC}; V_i = 0 \text{ V}; \text{ measured in test circuit of } Figure 11; unless otherwise specified.}$

	·					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage	operating	<u>[1]</u> 9	18	28	V
lq	quiescent current	V_{CC} = 18 V; R_{L} = ∞	-	60	100	mA
I _{CC(stb)}	standby supply current	V _{CC} = 18 V; V _{I(VC)} < 0.8 V	-	-	150	μΑ
Po	output power	$\label{eq:thdef} \begin{array}{l} THD = 10 \ \%; \ R_L = 4 \ \Omega; \\ V_CC = 18 \ V \end{array}$	7	8.5	-	W
		THD = 10 %; R _L = 4 Ω ; V _{CC} = 22 V	-	14	-	W
THD	total harmonic distortion	$P_o = 1 W$	-	0.1	0.5	%
G _{v(max)}	maximum voltage gain	$V_{I(VC)} > 5.0V$	25	26	27	dB
ΔG_v	voltage gain range	$1.5 \text{ V} < \text{V}_{I(\text{VC})} < 5.0 \text{ V}$	-	80	-	dB
SVRR	supply voltage ripple rejection	f = 1 kHz	[2] _	60	-	dB

[1] A minimum load of 3 Ω is allowed at supply voltages > 22 V.

[2] Supply voltage ripple rejection is measured at the output, with a source impedance $Z_S = 0 \Omega$ at the input and with a frequency range from 20 Hz to 22 kHz (unweighted). The ripple voltage is a sine wave with a frequency f_{ripple} and an amplitude of 300 mV (RMS), which is applied to the positive supply rail.

5. Ordering information

Table 2. Ordering information						
Туре	Package					
number	Name	Description	Version			
TFA9843AJ	DBS9P	plastic DIL-bent-SIL power package; 9 leads (lead length 12/11 mm); exposed die pad	SOT523 -1			

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6. Block diagram



7. Pinning information

7.1 Pinning



Table 3.	Pin description	
Symbol	Pin	Description
IN2	1	input 2
OUT2	2	loudspeaker terminal 2
CIV	3	common input voltage decoupling
IN1	4	input 1
GND	5	ground
SVR	6	half supply voltage decoupling (ripple rejection)
VC	7	volume control input (standby, mute and volume control)
OUT1	8	loudspeaker terminal 1
V _{CC}	9	supply voltage

7.2 Pin description

8. Functional description

8.1 Input configuration

The input cut-off frequency is as follows:

$$f_{i(-3dB)} = \frac{1}{2\pi(R_i \times C_i)} \tag{1}$$

Single-ended application: $R_i = 60 \text{ k}\Omega$ and $C_i = 220 \text{ nF}$:

$$f_{i(-3dB)} = \frac{1}{2\pi(60 \times 10^3 \times 220 \times 10^{-9})} = 12 \text{ Hz}$$
(2)

As shown in <u>Equation 2</u>, large capacitor values for the inputs are not necessary; therefore switch-on delay during charging of the input capacitors can be minimized. This results in a good low frequency response and good switch-on behavior.

The TFA9843AJ has clamps on the inputs. In Standby mode the voltage on the input pins is clamped for voltages lower than -0.1 V. When the TFA9843AJ is in Mute, Volume control or Operating mode (maximum gain) the input clamp voltage is 1 V (RMS).

8.2 Power amplifier

The power amplifier is a single-ended amplifier with an all NPN output stage, capable of delivering a peak output current of 4 A.

8.2.1 Output power measurement

The output power as a function of the supply voltage is measured on the output pins at THD = 10 %; see Figure 7. The maximum output power is limited by the supply voltage of 26 V and the maximum available output current is 4 A repetitive peak current. A minimum load of 3 Ω is required for supply voltages > 22 V; see Figure 4. The output power is measured with one channel driven.

8.2.2 Headroom

Typical CD music requires at least 12 dB (factor 15.85) dynamic headroom, compared to the average power output, for transferring the loudest parts without distortion. At $V_{CC} = 18$ V and $P_o = 6.5$ W (SE with $R_L = 4 \Omega$) at THD < 0.5 % (see Figure 5), the Average Listening Level (ALL) music power without any distortion yields:

$$P_{o(ALL, SE)} = \frac{6.5}{15.85} = 410 \text{ mW}$$
 (3)

The power dissipation can be derived from Figure 8 (SE) for 0 dB respectively 12 dB headroom; see Table 4.

For the average listening level a power dissipation of 4.2 W can be used for a heatsink calculation.

Headroom	Power output (THD < 0.5 %) (SE)	Power dissipation (P); both channels driven
0 dB	P _o = 6.5 W	8.2 W
12 dB	$P_{o(ALL)} = 410 \text{ mW}$	4.2 W

Table 4. Power rating as function of headroom

8.3 Mode selection

The TFA9843AJ has four functional modes, which can be selected by applying the proper DC voltage to pin VC; see Table 5.

Table 5. Mo	de selection	
V _{I(VC)}	Status	Definition
0 V to 0.8 V	Standby	in this mode the current consumption is very low and the outputs are floating; the device is in Standby mode when $V_{I(VC)} < 0.8 \text{ V}$
1.2 V to 1.5 V	Mute	in this mode the amplifier is DC-biased but not operational (no audio output); this allows the input coupling capacitors to be charged to avoid plop noise; the device is in Mute mode when $1.2 \text{ V} < \text{V}_{I(\text{VC})} < 1.5 \text{ V}$
1.5 V to 5.0 V	Volume control	in this mode the volume of the amplifier can be controlled; the gain can be adjusted between the range of 1.5 V < $V_{I(VC)}$ < 5.0 V
5.0 V to $V_{\mbox{\scriptsize CC}}$	On (maximum gain)	in this mode the amplifier has its maximum gain; the Operating mode is activated at $V_{I(\text{VC})}$ > 5.0 V

8.4 Supply voltage ripple rejection

The supply voltage ripple rejection (SVRR) is measured with an electrolytic capacitor of 150 μ F connected to pin SVR with a bandwidth of 20 Hz to 22 kHz. The SVRR as a function of the frequency is illustrated in Figure 10. A larger capacitor value on pin SVR improves the ripple rejection behavior at the lower frequencies.

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8.5 Built-in protection circuits

The TFA9843AJ contains two types of temperature sensors; one measures the local temperatures of the power stages and one measures the global chip temperature. At a local temperature of the power stage of approximately 185 °C or a global temperature of approximately 150 °C this detection circuit switches off the power stages for 2 ms. When the outputs are switched off the voltage is measured on the outputs. In the event of a short-circuit to ground or to V_{CC} the device will remain in Protection mode. In all other cases the power stages switch-on automatically and the detection will take place again; however a too high temperature will switch-off the power stages immediately. This can result in repetitive switching during too high junction temperature. This protects the TFA9843AJ against short-circuits to ground, to the supply voltage, across the load and too high chip temperatures.

The protection will only be activated when necessary, so even during a short-circuit condition, a certain amount of (pulsed) current will still flow through the short-circuit (as much as the power stage can handle without exceeding the critical temperature level).

9. Limiting values

Table 6.Limiting valuesIn accordance with the Absolute Maximum Rating System (IEC 60134).						
Symbol	Parameter	Conditions	Min	Max	Unit	
V _{CC}	supply voltage	operating	-0.3	+28	V	
VI	input voltage		-0.3	$V_{CC} + 0.3$	V	
I _{ORM}	repetitive peak output current		-	4	А	
T _{stg}	storage temperature	non-operating	-55	+150	°C	
T _{amb}	ambient temperature	operating	-40	+85	°C	
P _{tot}	total power dissipation		-	35	W	
V _{CC(scp)}	short-circuit protection supply voltage		-	26	V	

10. Thermal characteristics

Table 7.	Thermal characteristics			
Symbol	Parameter	Conditions	Value	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	40	K/W
R _{th(j-c)}	thermal resistance from junction to case	both channels driven	2.0	K/W

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11. Static characteristics

Table 8. Static characteristics

 $V_{CC} = 18 \text{ V}; T_{amb} = 25 \text{ °C}; R_L = 4 \Omega; V_{l(VC)} = V_{CC}; V_i = 0 \text{ V}; \text{ measured in test circuit of } Figure 11; unless otherwise specified.}$

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{CC}	supply voltage	operating	<u>[1]</u>	9	18	28	V
lq	quiescent current	R _L = ∞		-	60	100	mA
I _{CC(stb)}	standby supply current	V_{CC} = 18 V; $V_{I(VC)} < 0.8$ V		-	-	150	μA
Vo	output voltage		[2]	-	9	-	V
V _{I(VC)}	input voltage on pin VC	On mode (maximum gain)		5.0	-	V _{CC}	V
		Volume control mode		1.5	-	5.0	V
		Mute mode		1.2	-	1.5	V
		Standby mode		0	-	0.8	V
I _{I(VC)}	input current on pin VC	$0 V < V_{I(VC)} < V_{CC}$		-	-	20	μA

[1] A minimum load of 3 Ω is allowed at supply voltages > 22 V.

[2] The DC output voltage with respect to ground is approximately $0.5V_{CC}$.

12. Dynamic characteristics

Table 9. Dynamic characteristics SE

 $V_{CC} = 18 \text{ V}$; $T_{amb} = 25 \circ C$; $R_L = 4 \Omega$; f = 1 kHz; $V_{I(VC)} = V_{CC}$; measured in test circuit of Figure 11; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Po	output power	THD = 10 %; R _L = 4 Ω	7	8.5	-	W
		THD = 0.5 %; ${\sf R}_{\sf L}$ = 4 Ω	-	6.5	-	W
		$\label{eq:V_CC} \begin{array}{l} V_{CC} = 22 \; V; \\ THD = 10 \; \%; \; R_L = 4 \; \Omega \end{array}$	-	14	-	W
THD	total harmonic distortion	$P_o = 1 W$	-	0.1	0.5	%
G _{v(max)}	maximum voltage gain	$V_{I(VC)} > 5.0 V$	25	26	27	dB
ΔG_v	voltage gain range	$1.5 \text{ V} < \text{V}_{I(\text{VC})} < 5.0 \text{ V}$	-	80	-	dB
Vi	input voltage	gain = 0 dB; THD < 1 %	1.0		-	V
Zi	input impedance		40	60	-	kΩ
V _{n(o)}	noise output voltage		<u>[1]</u> _	150	-	μV
SVRR	supply voltage ripple	f _{ripple} = 1 kHz	[2] _	60	-	dB
	rejection	f _{ripple} = 100 Hz to 20 kHz	[2] _	60	-	dB
V _{o(mute)}	mute output voltage		<u>[3]</u>	-	150	μV
α_{cs}	channel separation	$Z_{\rm S} = 0 \ \Omega$	50	60	-	dB
$ \Delta G_{v(max)} $	maximum voltage gain difference		-	-	1	dB

- [1] The noise output voltage is measured at the output in a frequency range from 20 Hz to 22 kHz (unweighted), with a source impedance $Z_S = 0 \Omega$ at the input.
- [2] Supply voltage ripple rejection is measured at the output, with a source impedance $Z_S = 0 \Omega$ at the input and with a frequency range from 20 Hz to 22 kHz (unweighted). The ripple voltage is a sine wave with a frequency f_{ripple} and an amplitude of 300 mV (RMS), which is applied to the positive supply rail.
- [3] Output voltage in Mute mode ($V_{I(VC)}$ = 1.35 V) and an input voltage of 1 V (RMS) in a bandwidth from 20 Hz to 22 kHz, including noise.



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13. Application information

13.1 Application diagrams

13.1.1 Single-ended application



Remark: By switching inductive loads, the output voltage can rise beyond the maximum supply voltage of 28 V. At high supply voltage it is recommended to use (Schottky) diodes between the supply voltage and ground.

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13.1.2 Volume control drive options







13.2 Printed-circuit board

13.2.1 Layout and grounding

To obtain a high-level system performance, certain grounding techniques are essential. The input reference grounds have to be tied with their respective source grounds and must have separate tracks from the power ground tracks; this will prevent the large output signal currents from interfering with the small AC input signals. The small-signal ground tracks should be physically located as far as possible from the power ground tracks. Supply and output tracks should be as wide as possible for delivering maximum output power.



13.2.2 Power supply decoupling

Proper supply bypassing is critical for low-noise performance and high supply voltage ripple rejection. The respective capacitor location should be as close as possible to the device and connected to the power ground. Proper power supply decoupling also prevents unwanted oscillations.

For suppressing higher frequency transients (spikes) on the supply rail a capacitor with low ESR (typical 100 nF) has to be placed as close as possible to the device. For suppressing lower frequency noise and ripple signals, a large electrolytic capacitor (e.g. 1000 μ F or greater) must be placed close to the device.

The bypass capacitor connected to pin SVR reduces the noise and ripple on the mid rail voltage. For good THD and noise performance, a low ESR capacitor is recommended.

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13.3 Thermal behavior and heatsink calculation

The measured maximum thermal resistance of the IC package, $R_{th(j-mb)}$, is 2.0 K/W. A calculation for the heatsink can be made, with the following parameters:

$$\begin{split} T_{amb(max)} &= 60 \ ^\circ C \ (example) \\ V_{CC} &= 18 \ V \ and \ R_L = 4 \ \Omega \ (SE) \\ T_{j(max)} &= 150 \ ^\circ C \ (specification) \end{split}$$

 $R_{th(tot)}$ is the total thermal resistance between the junction and the ambient including the heatsink. This can be calculated using the maximum temperature increase divided by the power dissipation:

$$R_{th(tot)} = (T_{j(max)} - T_{amb(max)})/P$$

At V_{CC} = 18 V and R_L = 4 Ω (2 × SE) the measured worst case sine wave dissipation is 8.4 W; see <u>Figure 8</u>. For T_{j(max)} = 150 °C the temperature raise, caused by the power dissipation, is: 150 – 60 = 90 °C:

$$\begin{split} P \times R_{th(tot)} &= 90 \ ^{\circ}C \\ R_{th(tot)} &= 90/8.4 \ \text{K/W} = 10.7 \ \text{K/W} \\ R_{th(h-a)} &= R_{th(tot)} - R_{th(j-mb)} = 10.7 \ \text{K/W} - 2.0 \ \text{K/W} = 8.7 \ \text{K/W} \end{split}$$

This calculation is for an application at worst case (stereo) sine wave output signals. In practice music signals will be applied, which decreases the maximum power dissipation to approximately half of the sine wave power dissipation; see <u>Section 8.2.2</u>. This allows the use of a smaller heatsink:

$$\begin{split} \mathsf{P} \times \mathsf{R}_{th(tot)} &= 90 \ ^{\circ}\mathsf{C} \\ \mathsf{R}_{th(tot)} &= 90/4.2 \ \mathsf{K/W} = 21.4 \ \mathsf{K/W} \\ \mathsf{R}_{th(h-a)} &= \mathsf{R}_{th(tot)} - \mathsf{R}_{th(j-mb)} = 21.4 \ \mathsf{K/W} - 2.0 \ \mathsf{K/W} = 19.4 \ \mathsf{K/W} \end{split}$$

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14. Test information

14.1 Quality information

The General Quality Specification for Integrated Circuits, SNW-FQ-611 is applicable.

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15. Package outline



Fig 17. Package outline SOT523-1 (DBS9P)

16. Soldering

16.1 Introduction to soldering through-hole mount packages

This text gives a brief insight to wave, dip and manual soldering. A more in-depth account of soldering ICs can be found in our *Data Handbook IC26; Integrated Circuit Packages* (document order number 9398 652 90011).

Wave soldering is the preferred method for mounting of through-hole mount IC packages on a printed-circuit board.

16.2 Soldering by dipping or by solder wave

Driven by legislation and environmental forces the worldwide use of lead-free solder pastes is increasing. Typical dwell time of the leads in the wave ranges from 3 seconds to 4 seconds at 250 °C or 265 °C, depending on solder material applied, SnPb or Pb-free respectively.

The total contact time of successive solder waves must not exceed 5 seconds.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified maximum storage temperature $(T_{stg(max)})$. If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the permissible limit.

16.3 Manual soldering

Apply the soldering iron (24 V or less) to the lead(s) of the package, either below the seating plane or not more than 2 mm above it. If the temperature of the soldering iron bit is less than 300 °C it may remain in contact for up to 10 seconds. If the bit temperature is between 300 °C and 400 °C, contact may be up to 5 seconds.

16.4 Package related soldering information

Table 10.	Suitability of through-hole mount IC packages for dipping and wave soldering
	methods

Package	Soldering method				
	Dipping	Wave			
CPGA, HCPGA	-	suitable			
DBS, DIP, HDIP, RDBS, SDIP, SIL	suitable	suitable ^[1]			
PMFP ^[2]	-	not suitable			

[1] For SDIP packages, the longitudinal axis must be parallel to the transport direction of the printed-circuit board.

[2] For PMFP packages hot bar soldering or manual soldering is suitable.

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17. Revision history

Table 11. Revision history							
Document ID	Release date	Data sheet status	Change notice	Supersedes			
TFA9843AJ_1	20060428	Preliminary data sheet	-	-			

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18.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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